TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIV)

TK25A10K3

Swiching Regulator Applications

• Low drain-source ON resistance: RDS (ON) = 31 m Ω (typ.)

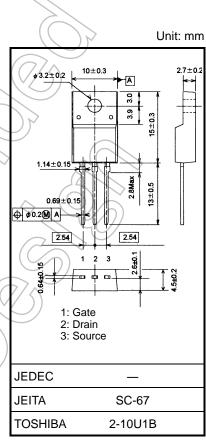
• High forward transfer admittance: |Yfs| = 50 S (typ.)

Low leakage current: IDSS = 10 μA (max) (VDS = 100 V)

Enhancement-model: Vth = 2.0 to 4.0 V (VDS = 10 V, ID = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			V_{DSS}	100	(y)	
Drain-gate voltage (RGS = $20 \text{ k}\Omega$)			VDGR	100	(
Gate-source voltage			V _{GSS}	±20	V	
Drain current	DC	(Note 1)	ΙD	25	A	
Drain current	Pulse	(Note 1)	I _{DP}	50	> A	
Drain power dissipat	Drain power dissipation (Tc = 25°C)			25	W	
Single pulse avalanche energy (Note 2)			EAS	39	mJ	
Avalanche current			IAR	25	A	
Repetitive avalanche energy (Note 3)			EAR) 1.72	mJ	
Channel temperature			Tch	150	_ °C	
Storage temperature range			(T _{stg}))	-55 to 150	//c	



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of

high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

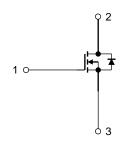
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: VDD = 25 V, $Tch = 25^{\circ}\text{C}(initial)$, $L = 100 \mu\text{H}$, $RG = 25 \Omega$, IAR = 25 A

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th(ch-c)}	5.0	°C/W
Thermal resistance, channel to ambient	R _{th(ch-a)}	62.5	°C/W



This transistor is an electrostatic sensitive device. Please handle with caution.

Start of commercial production 2009-06

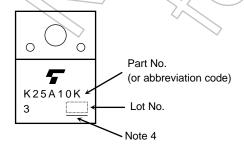
Electrical Characteristics (Ta = 25°C)

Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	IGSS	VGS = ±20 V, VDS = 0 V	_	_	±100	nA
Drain cut-OFF cu	rrent	IDSS	V _{DS} = 100 V, V _{GS} = 0 V	_	_	10	μΑ
Drain-source breakdown voltage		V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V
		V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	65	1	1	V
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0))_	4.0	V
Drain-source ON resistance		R _{DS(ON)}	V _{GS} = 10 V, I _D = 12 A	<u> </u>	31	40	mΩ
Forward transfer admittance		Yfs	V _{DS} = 10 V, I _D = 12 A	25	50	_	S
Input capacitance		Ciss		> —	1580	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	135	_	pF
Output capacitance		Coss		_	200	/	
Switching time	Rise time	tr	10 V	_{<	13	\ (ns
	Turn-on time	t _{on}	V_{GS} 0 V_{OUT} $R_{L} = 4 \Omega$		25	_	
	Fall time	tf	V _{DD} ≈ 50 V	1	8	_	
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs) –	37	-	
Total gate charge (gate-source plus gate-drain)		Qg		_	34		
Gate-source charge		Qgs1	V _{DD} ≈ 80 V, V _{GS} = 10 V, I _D = 25 A	_	7	_	nC
Gate-drain ("miller") charge		Qgd		_	13	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

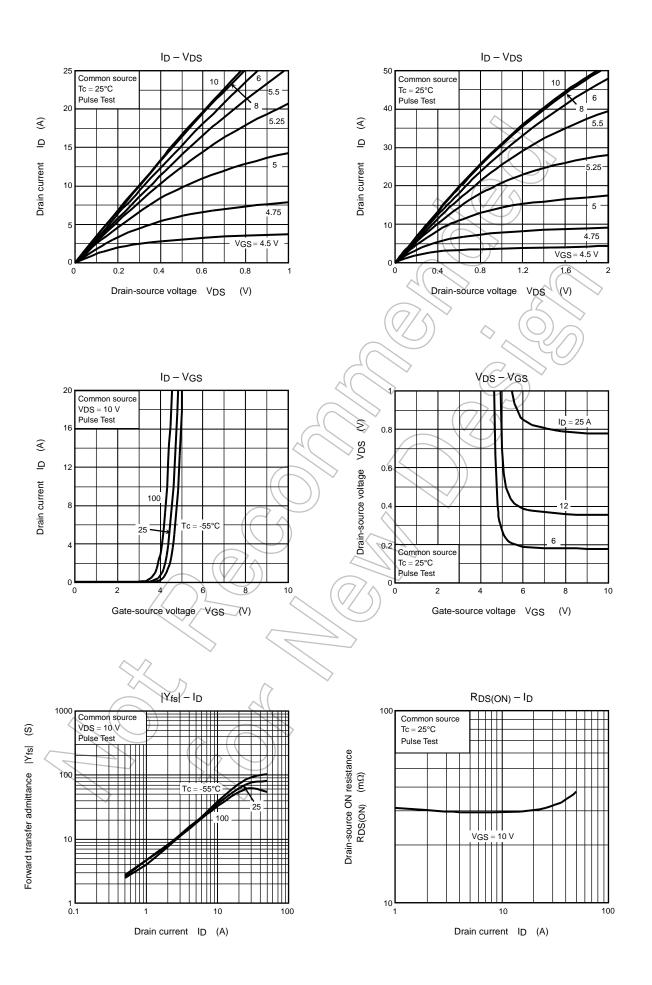
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	25	Α
Pulse drain reverse current (Note 1)	IDRP	_	_	_	50	Α
Forward voltage (diode)	VDSF	I _{DR} = 25 A, V _{GS} = 0 V	_	_	-1.4	V
Reverse recovery time	/\$rr	I _{DR} = 25 A, V _{GS} = 0 V,	_	57	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 50 A/μs	_	61	_	nC

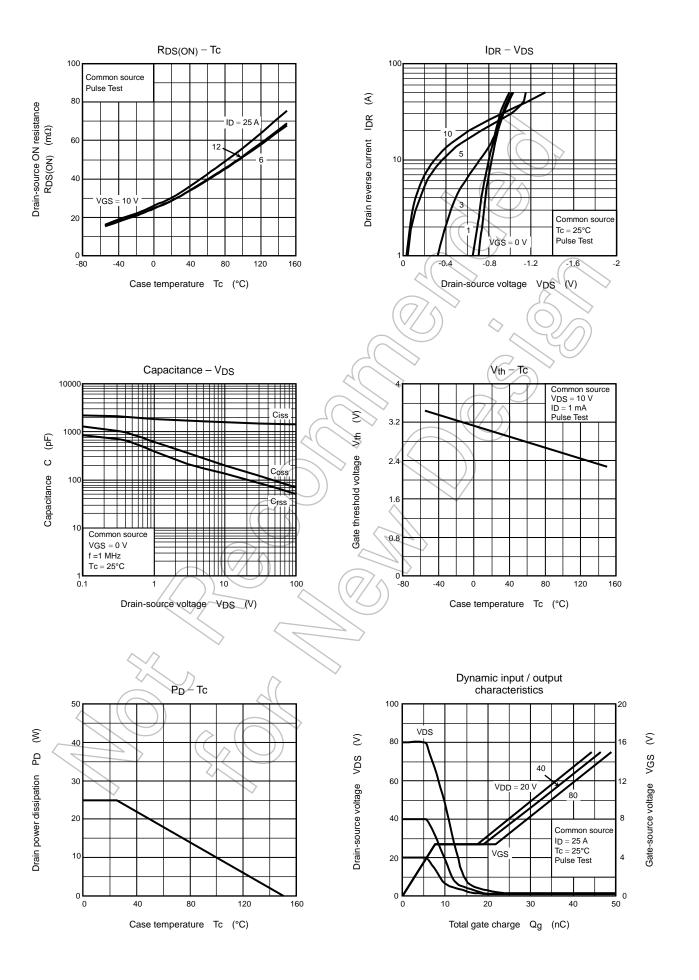
Marking

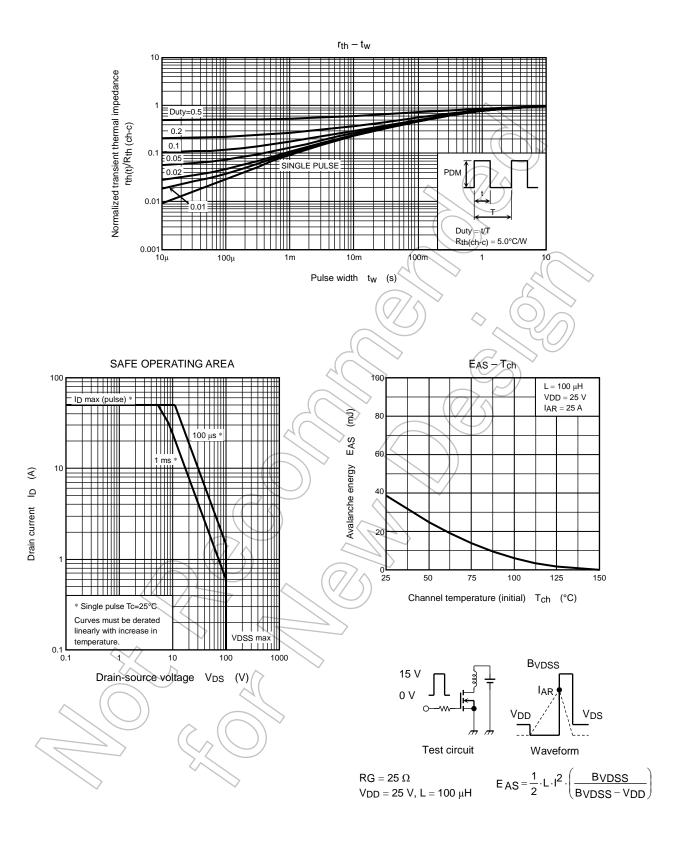


Note 4: A line under a Lot No. identifies the indication of product Labels Not underlined: [[Pb]]/INCLUDES > MCV
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment







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